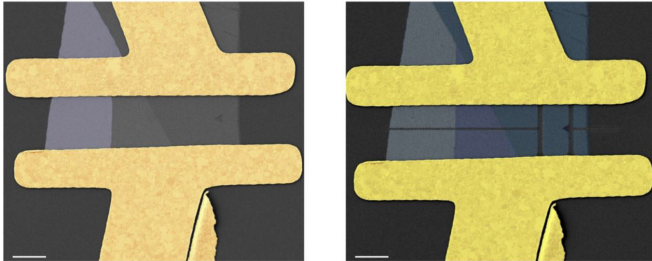


# Direct after-fabrication tailoring of molybdenum disulphide transistors

8 July 2019, by Elena Alonso-Redondo



MoS<sub>2</sub> FET device before and after the pulsed-focused electron beam induced etching (pulsed-FEBIE) nanopatterning, with a tailored conduction channel. Credit: Fernando J. Urbanos

The fabrication of electronic devices from exfoliated 2-D materials can be tricky. The group of Daniel Granados at IMDEA Nanociencia has engineered a solution that consists of the after-fabrication tailoring of MoS<sub>2</sub>-FET transistors using pulsed-focused electron beam induced etching.

Transition metal dichalcogenides are 2-D, atomically thin layers bound together by Van der Waals forces. These materials exhibit thickness-dependent variations in their physical properties that can be exploited in distinct optoelectronic applications. For example, the band structure of molybdenum disulphide (MoS<sub>2</sub>) has a direct bandgap of 1.8 eV in a single layer that narrows down with thickness of 1.2 eV indirect bandgap in bulk.

The atomically thin layers of MoS<sub>2</sub> can be separated by micromechanical exfoliation, nonetheless the fabrication of optoelectronic devices from mechanically exfoliated MoS<sub>2</sub> is an intricate process. The geometry of the device is limited in all cases by the shape of the exfoliated flake, even when a deterministic stamping method is employed. Even when using CVD ([chemical vapour deposition](#)) techniques the device

fabrication is hindered by the material growing in islands with reduced sizes and different physical properties.

Thus, developing techniques to tailor the device geometry after the fabrication steps are completed is of great interest. The group of Prof. Daniel Granados at IMDEA Nanociencia has come to a smart solution by modifying the geometry of several field effect transistors (FET) fabricated out of exfoliated MoS<sub>2</sub>. The proposed method uses a variation of focused electron beam-induced etching (FEBIE) with a pulsed electron beam. The beam scans the surface into a designed geometry employing a pattern generator, modifying of the conduction channel between the source and the drain of the transistor and allowing a tailor-made device performance.

Prof. Granados likes to use the hydrodynamic analogy: "It is like [turbulent flow](#), after passing certain apertures it becomes laminar; our tailored conduction channels allow the electrons passing by areas of the MoS<sub>2</sub> flakes with identical properties."

The effect of this method has been studied further to verify the performance of the modified devices. Granados' group has found that 90 percent of the devices work after the nanopatterning. Further, they studied the shift that is produced from clear heavily N-type doping towards intrinsic or lightly P-type, and attributed this change to sulphur vacancies created when etching. The doping shift was confirmed by photoluminescence and Raman spectroscopy studies.

This method presents several advantages compared to those that use several fabrication steps. First, it combines patterning and etching into a single step instead of having a two-step nanofabrication process. Second, it allows electronic and optical characterization before and after the tailoring step in a simple scheme. Last, the pulsed-FEBIE is a chemical method with an

[electron beam](#) energy lower than other studies (2.5 kV), which reduces the sample damage and prevents the distortion of the MoS<sub>2</sub> lattice. Because of these advantages, the nanoscissors proposed by Granados et al. are a remarkable alternative to expensive and time-consuming nanofabrication techniques, and have great potential for the after-fabrication tailoring of the electrical and geometrical properties of electronic and optoelectronic devices.

**More information:** Fernando J. Urbanos et al. Electrical and geometrical tuning of MoS<sub>2</sub> field effect transistors via direct nanopatterning, *Nanoscale* (2019). [DOI: 10.1039/C9NR02464F](https://doi.org/10.1039/C9NR02464F)

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